

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE01H10 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

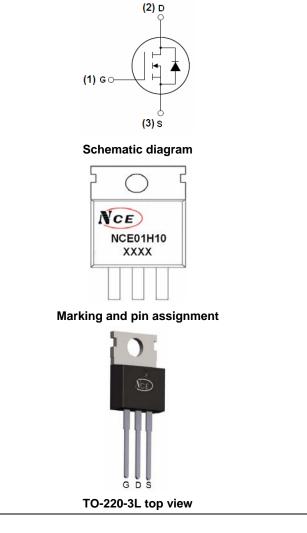
- V_{DS} = 100V,I_D =100A
 R_{DS(ON)} < 13mΩ @ V_{GS}=10V (Typ:9.9mΩ)
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

	Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
Ī	NCE01H10	NCE01H10	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_c=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit	
Vds	Drain-Source Voltage	100	V	
Vgs	Gate-Source Voltage	±20	V	
I _D	Drain Current-Continuous	100	А	
l _D (100℃)	Drain Current-Continuous(TC=100°C)	80	А	
I _{DM}	Pulsed Drain Current	380	А	
PD	Maximum Power Dissipation	200	W	
	Derating factor	1.33	W/℃	
E _{AS}	Single pulse avalanche energy (Note 5)	800	mJ	
T_{J}, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 175	°C	



Pb Free Product

NCE01H10

Thermal Characteristic

R _{θJC} Thermal Resistance, Junction-to-Case (Note 2)0.75°C/

Electrical Characteristics (T_c=25°C unless otherwise noted)

	Symbol Para	ameter	Condition	Min	Тур	Max	Unit
Off Characterist	ics						
BV _{DSS}	Drain-Source Breakdown	Voltage	V _{GS} =0V I _D =250µA	100	110	-	V
I _{DSS}	Zero Gate Voltage Drain (Current	V _{DS} =100V,V _{GS} =0V	-	-	1	μA
I _{GSS}	Gate-Body Leakage Cu	Gate-Body Leakage Current		-	-	±100	nA
On Characterist	ics (Note 3)						
V _{GS(th)}	Gate Threshold Voltag	ge	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2	3	4	V
R _{DS(ON)}	Drain-Source On-State Res	sistance	V _{GS} =10V, I _D =40A	-	9.9	13	mΩ
g _{FS}	Forward Transconducta	ance	V _{DS} =50V,I _D =40A	100	-	-	S
Dynamic Charac	cteristics (Note4)			•			
C _{lss}	Input Capacitance			-	4800	-	PF
C _{oss}	Output Capacitance	;	V_{DS} =50V, V_{GS} =0V,	-	340	-	PF
C _{rss}	Reverse Transfer Capaci	itance	F=1.0MHz	-	150	-	PF
Switching Chara	acteristics (Note 4)			•			
t _{d(on)}	Turn-on Delay Time	9		-	15	-	nS
tr	Turn-on Rise Time		V _{DD} =50V,I _D =40A	-	50	-	nS
t _{d(off)}	Turn-Off Delay Time	Э	V_{GS} =10V, R_{GEN} =2.5 Ω	-	40	-	nS
t _f	Turn-Off Fall Time			-	55	-	nS
Qg	Total Gate Charge		<u>)/ 00)// 404</u>	-	85	-	nC
Q _{gs}	Gate-Source Charge	е	V_{DS} =80V,I _D =40A,	-	18	-	nC
Q _{gd}	Gate-Drain Charge		V _{GS} =10V	-	28	-	nC
Drain-Source Di	ode Characteristics						
V _{SD}	Diode Forward Voltage	Note 3)	V _{GS} =0V,I _S =40A	-	-	1.2	V
Is	Diode Forward Current (-	-	-	57	А
t _{rr}	Reverse Recovery Tim	e	TJ = 25°C, IF = 40A	-	38	80	nS
Qrr	Reverse Recovery Char	ge	di/dt = 100A/µs(Note3)	-	53	100	nC
t _{on}	Forward Turn-On Time	e	Intrinsic turn-on time is negligible (turn-on is dominated by			y LS+LD)	

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition:Tj=25 $^\circ C$,V_DD=50V,V_G=10V,L=0.5mH,Rg=25\Omega

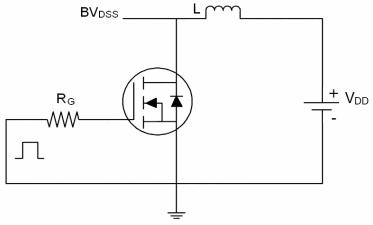


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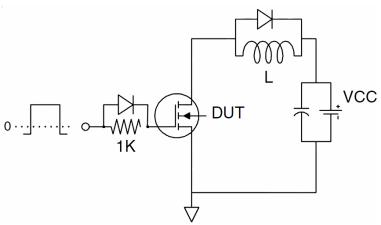




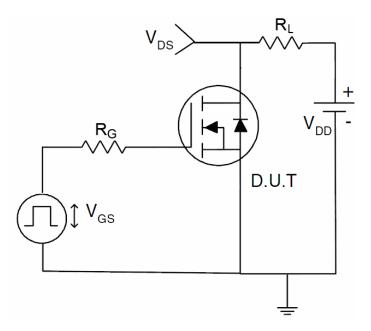
Test Circuit 1) E_{AS} test Circuit



2) Gate charge test Circuit



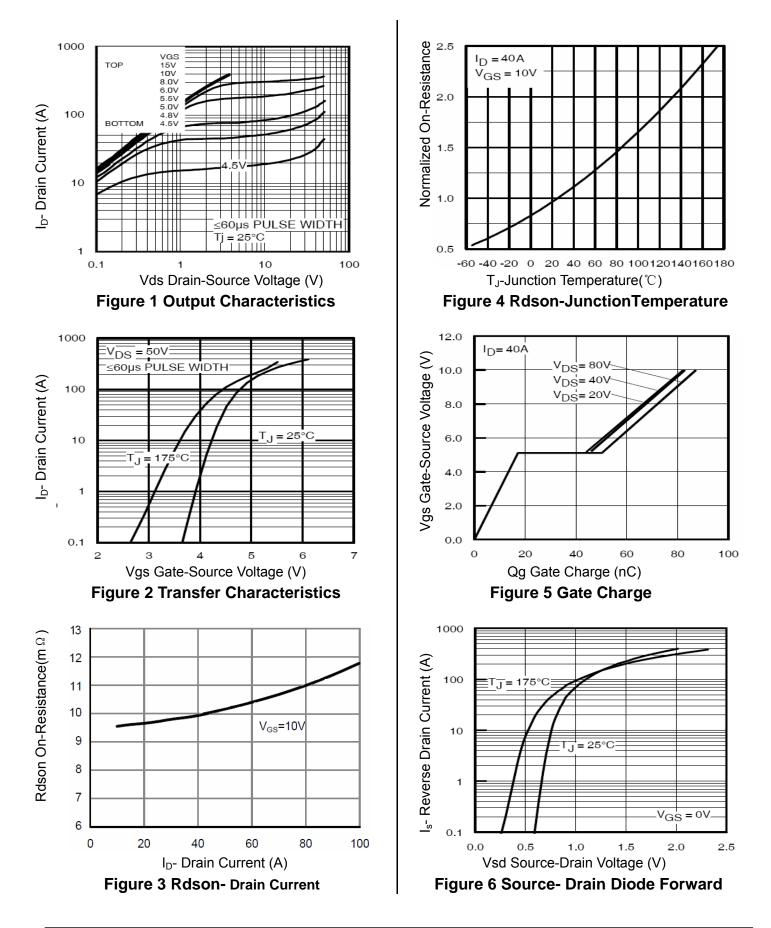
3) Switch Time Test Circuit





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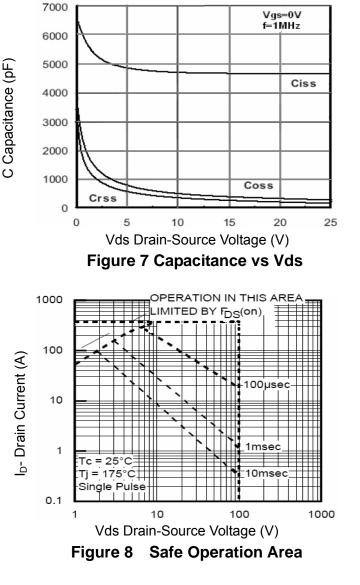
Typical Electrical and Thermal Characteristics (Curves)











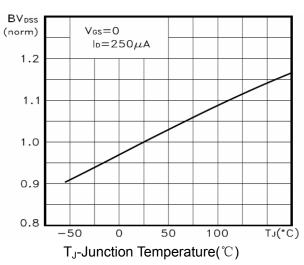


Figure 9 BV_{DSS} vs Junction Temperature

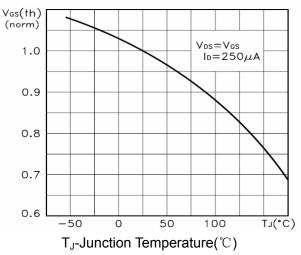
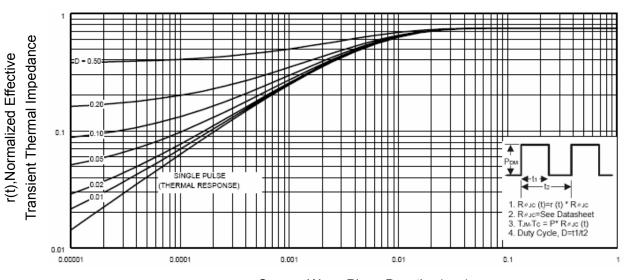


Figure 10 V_{GS(th)} vs Junction Temperature



Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance

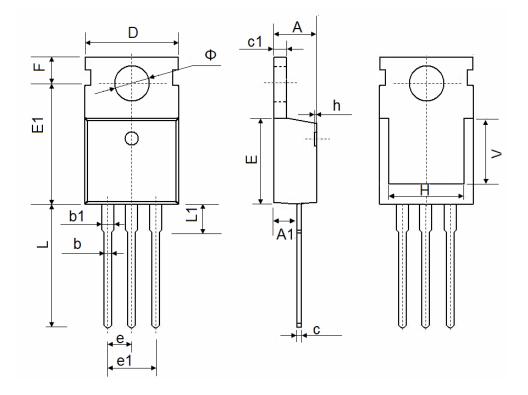
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TO-220-3L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540) TYP.	0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500) REF.	0.295 REF.		
Φ	3.400	3.800	0.134	0.150	







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